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N-Channel PowerTrench[®] MOSFET 30V, 35A, 7.0m Ω

Features

- Max $r_{DS(on)}$ = 7.0m Ω at V_{GS} = 10V, I_D = 14A
- Max r_{DS(on)} = 11.0mΩ at V_{GS} = 4.5V, I_D = 11.5A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- RoHS Compliant

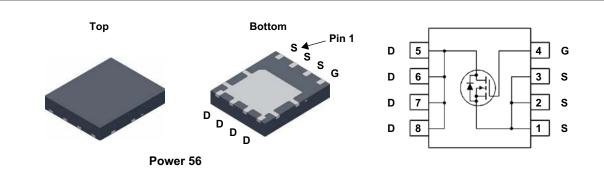


General Description

The FDMS8680 has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{DS(on)}$ while maintaining excellent switching performance.

Applications

- Low Side for Synchronous Buck to Power Core Processor
- Secondary Side Synchronous Rectifier
- Low Side Switch in POL DC/DC Converter
- Oring FET/ Load Switch



MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units
V _{DS}	Drain to Source Voltage			30	V
V _{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous (Package limited)	T _C = 25°C		35	
	-Continuous (Silicon limited)	T _C = 25°C		63	
D	-Continuous	T _A = 25°C	(Note 1a)	14	— A
	-Pulsed			100	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	216	mJ
P	Power Dissipation	T _C = 25°C		50	14/
PD	Power Dissipation	T _A = 25°C	(Note 1a)	2.5	W
TJ, TSTG	Operating and Storage Junction Temperature R	ange		-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 50	C/VV

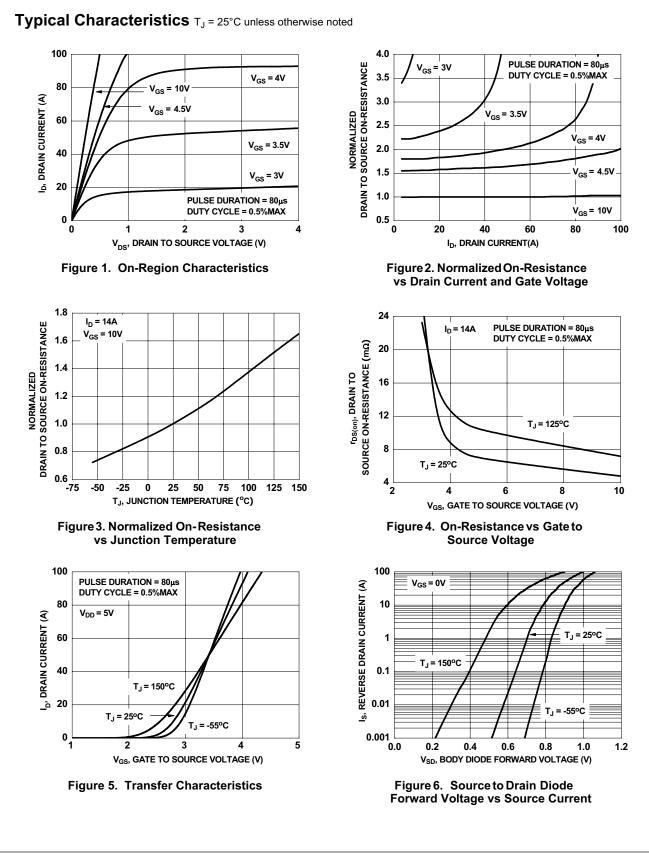
Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8680	FDMS8680	Power 56	13"	12mm	3000units

October 2014

	0 nA 0 V mV/° 0 mΩ 5 S 0 pF 0 pF 5 pF 0 Ω
$\begin{array}{ c c c c c c } BV_{DSS} & Drain to Source Breakdown Voltage & I_D = 250 \mu A, V_{GS} = 0V & 30 & & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & 24 & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & 24 & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & 24 & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & 24 & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & & 24 & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & & 1 & \\ \hline D = 250 \mu A, referenced to 25^\circ C & & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & & & \\ \hline D = 250 \mu A, referenced to 25^\circ C & & & \\ \hline D = 250 \mu$	mV/° μA 00 nA 00 V mV/° 0 mV/° 0 mΩ 5 S 00 pF 0 pF 0 pF 0 pF 0 pF
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$ I_{DSS} Zero Gate Voltage Drain Current \\ V_{DS} = 24V, V_{GS} = 0V \\ I_{GSS} Gate to Source Leakage Current \\ V_{GS} = \pm 20V, V_{DS} = 0V \\ \hline \ t100 \\ \hline \ Don Characteristics \\ \hline \ V_{GS(th)} Gate to Source Threshold Voltage \\ \hline \ V_{GS} = V_{DS}, I_D = 250 \mu A \\ \hline \ AT_J Gate to Source Threshold Voltage \\ \hline \ Temperature Coefficient \\ \hline \ AT_J Gate to Source Threshold Voltage \\ \hline \ Temperature Coefficient \\ \hline \ AT_J Gate to Source Threshold Voltage \\ \hline \ Temperature Coefficient \\ \hline \ V_{GS} = 10V, I_D = 14A \\ \hline \ V_{GS} = 10V, I_D = 14A, T_J = 125^{\circ}C \\ \hline \ Reverse Transconductance \\ \hline \ V_{DS} = 10V, I_D = 14A, T_J = 125^{\circ}C \\ \hline \ Reverse Transfer Capacitance \\ \hline \ C_{rss} \\ \hline \ Reverse Transfer Capacitance \\ \hline \ R_g \\ \hline \ Gate Resistance \\ \hline \ Reverse Transfer Capacitance \\ \hline \ R_g \\ \hline \ Gate Resistance \\ \hline \ Switching Characteristics \\ \hline \ turn-On Delay Time \\ \hline \ Turn-On Delay Time \\ \hline \ V_{CS} \\ \hline \ $	0 nA 0 V mV/° 0 mΩ 5 S 0 pF 0 pF 5 pF 0 Ω
$\begin{array}{c c c c c c c } \hline I_{GSS} & Gate to Source Leakage Current & V_{GS} = \pm 20V, V_{DS} = 0V & \pm 100 \\ \hline \\$	0 V mV/° 0 mΩ 5 S 00 pF 0 pF 5 pF 0 Ω
On Characteristics $V_{GS(th)}$ Gate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = 250\mu$ A1.01.83.0 $\Delta V_{GS(th)}$ Gate to Source Threshold Voltage Temperature Coefficient $I_D = 250\mu$ A, referenced to 25° C-5.7-5.7 $r_{DS(on)}$ Static Drain to Source On Resistance $V_{GS} = 10V$, $I_D = 14A$ 5.57.0 $V_{GS} = 10V$, $I_D = 14A$, $T_J = 125^{\circ}$ C8.210.5 g_{FS} Forward Transconductance $V_{DD} = 10V$, $I_D = 14A$ 72Dynamic Characteristics C_{iss} Input Capacitance C_{oss} $V_{DS} = 15V$, $V_{GS} = 0V$, $f = 1MHz$ 11951590 C_{rss} Reverse Transfer Capacitance $f = 1MHz$ 0.84.0Switching CharacteristicsSwitching Characteristics $t_{t(on)}$ Turn-On Delay Time918	mV/° 0 mΩ 5 S 00 pF 0 pF 5 pF 0 Ω
$\begin{array}{ c c c c } \hline V_{GS}(th) & Gate to Source Threshold Voltage & V_{GS} = V_{DS}, \ I_D = 250 \mu A & 1.0 & 1.8 & 3.0 \\ \hline \Delta V_{GS}(th) \\ \hline \Delta T_J & Gate to Source Threshold Voltage Temperature Coefficient & I_D = 250 \mu A, referenced to 25°C & -5.7 & V_{GS} = 10V, \ I_D = 14A & 5.5 & 7.0 \\ \hline V_{GS} = 10V, \ I_D = 14A & 5.5 & 7.0 \\ \hline V_{GS} = 10V, \ I_D = 14A, \ T_J = 125°C & 8.2 & 10.5 \\ \hline g_{FS} & Forward Transconductance & V_{DS} = 10V, \ I_D = 14A & 72 \\ \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	mV/° 0 mΩ 5 S 00 pF 0 pF 5 pF 0 Ω
$ \frac{\Delta V_{GS(th)}}{\Delta T_J} \begin{array}{c c} Gate to Source Threshold Voltage Temperature Coefficient & I_D = 250 \mu A, referenced to 25°C &5.7 & V_GS = 10V, I_D = 14A & 5.5 & 7.0 \\ \hline V_{GS} = 10V, I_D = 14A &5.5 & 11.0 \\ \hline V_{GS} = 4.5V, I_D = 11.5A & 8.5 & 11.0 \\ \hline V_{GS} = 10V, I_D = 14A, T_J = 125°C & 8.2 & 10.5 \\ \hline g_{FS} & Forward Transconductance & V_{DD} = 10V, I_D = 14A & 72 \\ \hline \end{array} $ $ \begin{array}{c} \hline Dynamic Characteristics & V_{DS} = 15V, V_{GS} = 0V, \\ \hline c_{rss} & Reverse Transfer Capacitance & V_{DS} = 15V, V_{GS} = 0V, \\ \hline f = 1MHz &555 & 740 \\ \hline c_{rss} & Reverse Transfer Capacitance & f = 1MHz &555 & 11.5 \\ \hline R_g & Gate Resistance & f = 1MHz &555 & 11.5 \\ \hline \end{array} $	mV/° 0 mΩ 5 S 00 pF 0 pF 5 pF 0 Ω
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$V_{GS} = 10V, I_D = 14A, T_J = 125^{\circ}C$ 8.210.5 g_{FS} Forward Transconductance $V_{DD} = 10V, I_D = 14A$ 72Dynamic Characteristics C_{iss} Input Capacitance $V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$ 11951590 C_{rss} Reverse Transfer Capacitance $V_{DS} = 15V, V_{GS} = 0V, f = 1MHz$ 95145 R_g Gate Resistancef = 1MHz0.84.0Switching Characteristics $t_{r(op)}$ Turn-On Delay Time918	5 S 00 pF 0 pF 5 pF 0 Ω
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Coss Output Capacitance VDS = 15V, VGS = 0V, f = 1MHz 555 740 Crss Reverse Transfer Capacitance f = 1MHz 95 145 Rg Gate Resistance f = 1MHz 0.8 4.0 Switching Characteristics Turn-On Delay Time 9 18	0 pF 5 pF 0 Ω
Crss Reverse Transfer Capacitance 1 95 145 Rg Gate Resistance f = 1MHz 0.8 4.0 Switching Characteristics 1 95 145 95 145 tr(on) Turn-On Delay Time 9 18 9 18	Ω (
Rg Gate Resistance f = 1MHz 0.8 4.0 Switching Characteristics Image: Characteristic structure 9 18	Ω (
Switching Characteristics	s ns
t _{d(on)} Turn-On Delay Time 9 18	ns
td(on) Tull-Of Delay fille 9 10	, 115
t- Rise Time $V_{DD} = 15V, I_D = 14A,$ 3 10	
$V_{GS} = 10V, R_{GEN} = 6\Omega$	
Q_{a} Total Gate Charge $V_{cs} = 0V$ to $5V$ $V_{DD} = 15V$, 10 14	
Q_{rr} Gate to Source Charge $I_D = 14A$ $I_D = 14A$	nC
90 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	nC
9- 1 - 1 1 1 1	
$l_{\Gamma} = 14A$, $di/dt = 100A/us$	
Q _{rr} Reverse Recovery Charge 15 27	ns
Q_g Total Gate Charge $V_{GS} = 0V \text{ to } 10V$ $V_{DD} = 15V$,1826 Q_g Total Gate Charge $V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 15V$,1014 Q_{gs} Gate to Source Charge Q_g $Q_$	

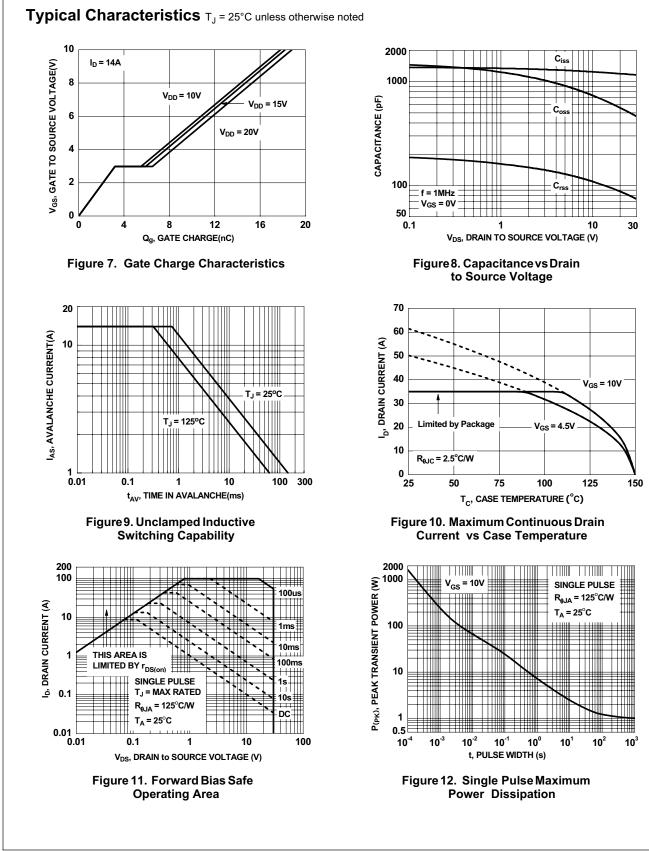
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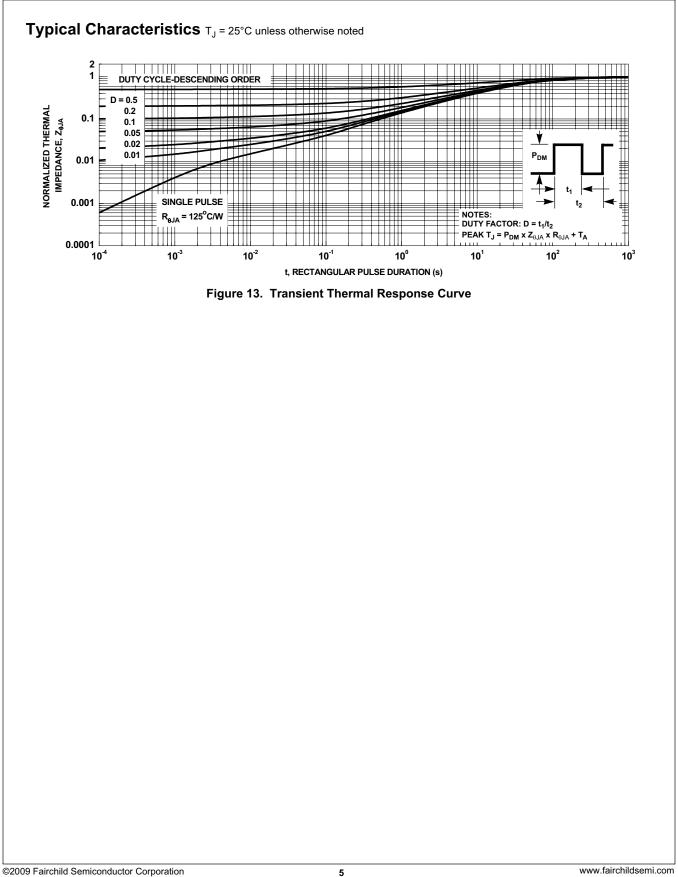
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